# Island Labs

## V.H.F. POWER TRANSISTOR

N-P-N silicon planar epitaxial transistor intended for use in class-A, B or C operated mobile transmitters with a nominal supply voltage of 13,5 V. The transistor is resistance stabilized and is guaranteed to withstand severe load mismatch conditions with a supply over-voltage to 16,5 V. The BFQ43 is especially suited as a driver transistor for the BLW31 in a two-stage wide-band or semi-wide-band v.h.f. amplifier delivering 28 W output power.

It has a TO-39 metal envelope with the emitter connected to the case, which enables excellent heatsinking and emitter grounding.

# QUICK REFERENCE DATA

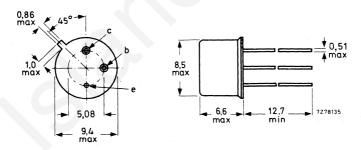
R.F. performance up to T<sub>h</sub> = 25 °C

mode of operation	V <sub>CE</sub> V	f MHz	P <sub>L</sub>	G <sub>p</sub> dB	η %	$\frac{\overline{z_i}}{\Omega}$	√L mA/V
c.w. class-B	13,5	175	4	> 12	> 55	3,2 + j0,03	53 – j29
c.w. class-B	12,5	175	4	typ. 12	typ. 60	_	_

## **MECHANICAL DATA**

Dimensions in mm

Fig. 1 TO-39; emitter connected to case.



Maximum lead diameter is guaranteed only for 12,7 mm.

Accessories supplied on request: 56218 (package); 56245 (distance disc).

## **RATINGS**

Limiting values in accordance with the Absolute Maximum System (IEC 134)

Collector-emitter voltage (V<sub>BE</sub> = 0) peak value

Collector-emitter voltage (open base)

Emitter-base voltage (open collector)

Collector current (average)

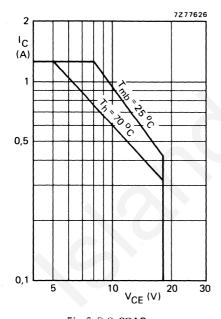
Collector current (peak value); f > 1 MHz

Total power dissipation up to T<sub>mb</sub> = 25 °C

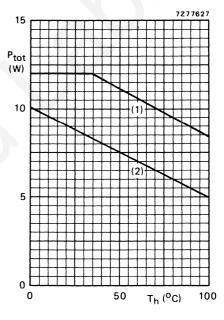
Storage temperature

Operating junction temperature

V <sub>CESM</sub>	max.	36	٧
$V_{CEO}$	max.	18	٧
V <sub>EBO</sub>	max.	4	٧
IC(AV)	max.	1,25	Α
I <sub>CM</sub>	max.	3,75	Α
P <sub>tot</sub>	max.	12	W
T <sub>stg</sub>	-65 to 4	- 150	oC
Тј	max.	200	oC







- (1) Short-time r.f. operation during mismatch;f ≥ 1 MHz.
- (2) Continuous d.c. and r.f. operation; derate by 0.05~W/OC.

Fig. 3 Total power dissipation;  $V_{CE} \le 16,5 \text{ V}$ .

THERMAL RESISTANCE (dissipation = 4 W;  $T_{mb}$  = 82 °C, i.e.  $T_h$  = 70 °C)

From junction to mounting base

R<sub>th j-mb</sub>

18 °C/W

From mounting base to heatsink

R<sub>th mb-h</sub>

3 °C/W

2

## **CHARACTERISTICS**

V(BR)CES	>	36	V
V <sub>(BR)</sub> CEO	>	18	V
V(BR)EBO	> 1	4	<b>V</b>
ICES	<	2	mA
ESBO ESBR	<b>&gt;</b>	0,5 0,5	
hFE	typ. 10 to	40 80	
V <sub>CEsat</sub>	typ.	0,9	V
f <sub>T</sub>			MHz MHz
C <sub>c</sub>	typ.	15	pF
C <sub>re</sub>	typ.	7,3	pF
	V(BR)CEO V(BR)EBO ICES ESBO ESBR hFE VCEsat fT fT Cc	V(BR)CEO > V(BR)EBO > ICES < ESBO > ESBR > hFE typ. 10 to VCEsat typ. fT typ. fT typ. fT typ. Cc typ.	V(BR)CEO > 18  V(BR)EBO > 4  ICES < 2  ESBO > 0,5 ESBR > 0,5 Typ. 40 10 to 80  VCEsat typ. 0,9  fT typ. 750 fT typ. 625  Cc typ. 15

<sup>\*</sup> Measured under pulse conditions:  $t_p \leqslant$  200  $\mu s; \, \delta \leqslant$  0,02.

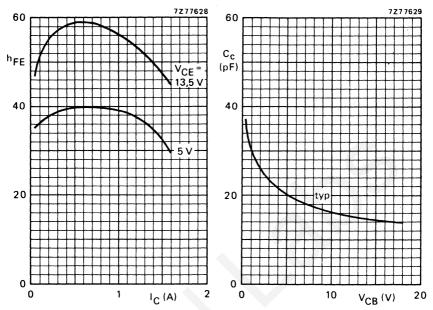


Fig. 4 Typical values;  $T_i = 25$  °C.

Fig. 5  $I_E = I_e = 0$ ; f = 1 MHz;  $T_j = 25$  °C.

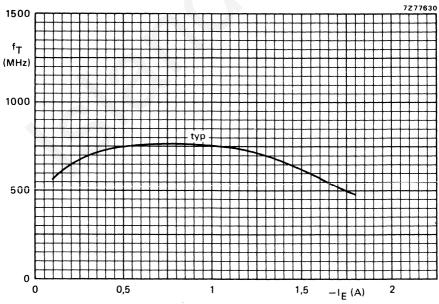


Fig. 6  $V_{CB}$  = 13,5 V; f = 100 MHz;  $T_j$  = 25 °C.

### APPLICATION INFORMATION

R.F. performance in c.w. operation (unneutralized common-emitter class-B circuit)

 $T_h = 25$  °C

f (MHz)	V <sub>CE</sub> (V)	P <sub>L</sub> (W)	P <sub>S</sub> (W)	Gp (dB)	I <sub>C</sub> (A)	η (%)	$\overline{z_i}(\Omega)$	YL (mA/V)
175	13,5	4	< 0,25	> 12	< 0,54	> 55	3,2 + j0,03	53 – j29
175	12,5	4	_	typ. 12	-	typ. 60	_	-

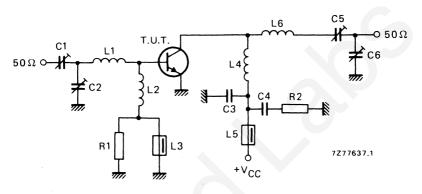


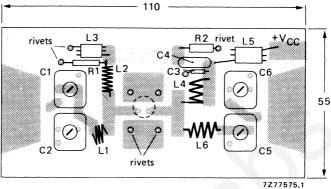
Fig. 7 Test circuit; c.w. class-B.

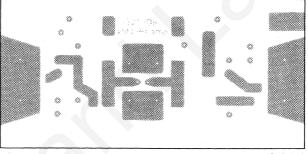
### List of components:

- C1 = C5 = 2,5 to 20 pF film dielectric trimmer (cat. no. 2222 809 07004)
- C2 = C6 = 4 to 40 pF film dielectric trimmer (cat. no. 2222 809 07008)
- C3 = 100 pF ceramic capacitor
- C4 = 100 nF polyester capacitor
- L1 = 2 turns Cu wire (1,0 mm); int. dia. 4,0 mm; length 3 mm; leads 2 x 5 mm
- L2 = 7 turns enamelled Cu wire (0,5 mm); int. dia. 3,0 mm; length 4 mm; leads 2 x 5 mm
- L3 = L5 = Ferroxcube wide-band h.f. choke, grade 3B (cat. no. 4312 020 36640)
- L4 = 4 turns enamelled Cu wire (1,0 mm); int. dia. 5,5 mm; length 5 mm; leads 2 x 5 mm
- L6 = 5 turns enamelled Cu wire (1,0 mm); int. dia. 5,5 mm; length 7,5 mm; leads 2 x 5 mm
- $R1 = R2 = 10 \Omega$  carbon resistor

Component layout and printed-circuit board for 175 MHz test circuit are shown in Fig. 8.

## **APPLICATION INFORMATION (continued)**





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Fig. 8 Component layout and printed-circuit board for 175 MHz test circuit.

The circuit and the components are situated on one side of the epoxy fibre-glass board, the other side being fully metallized to serve as earth. Earth connections are made by means of hollow rivets.

Material of printed-circuit board: 1,6 mm epoxy fibre-glass.

The case is directly grounded on the printed-circuit board.



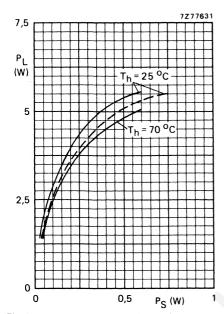
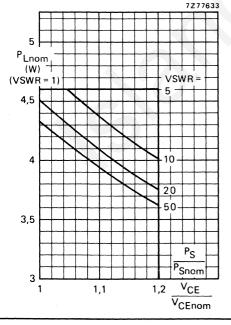


Fig. 9 Typical values; f = 175 MHz; ——  $V_{CE} = 13.5 \text{ V}$ ; ——  $V_{CE} = 12.5 \text{ V}$ .



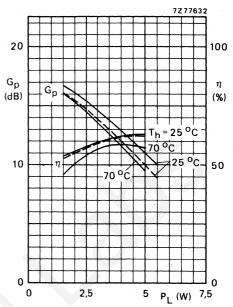


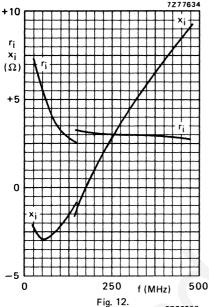
Fig. 10 Typical values; f = 175 MHz; —— V<sub>CE</sub> = 13,5 V; — — V<sub>CE</sub> = 12,5 V.

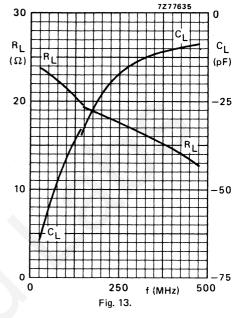
Fig. 11 R.F. SOAR (short-time operation during mismatch); f = 175 MHz;  $T_h = 70$  °C. Rth mb-h = 3 °C/W; VCEnom = 13,5 or 12,5 V; PS = PSnom at VCEnom and VSWR = 1.

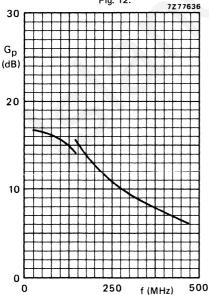
The transistor has been developed for use with unstabilized supply voltages. As the output power and drive power increase with the supply voltage, the nominal output power must be derated in accordance with the graph for safe operation at supply voltages other than the nominal. The graph shows the permissible output power under nominal conditions (VSWR = 1), as a function of the expected supply over-voltage ratio with VSWR as parameter.

The graph applies to the situation in which the drive  $(P_S/P_{Snom})$  increases linearly with supply over-voltage ratio.

**OPERATING NOTE** Below 140 MHz a base-emitter resistor of 10  $\Omega$  is recommended to avoid oscillation. This resistor must be effective for r.f. only.







Conditions for Figs 12, 13 and 14: Typical values;  $V_{CE}$  = 13,5 V;  $P_L$  = 4 W;  $T_h$  = 25 °C.

Fig. 14.